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Metallic conduction through van der Waals interfaces in ultrathin Bi_2Te_3 films

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While the van der Waals (vdW) interface in layered materials hinders the transport of charge carriers in the vertical direction, it serves a good horizontal conduction path. We have investigated electrical conduction of few quintuple-layer (QL) Bi_2Te_3 films by in situ four-point probe conductivity measurement. The impact of the vdW (Te–Te) interface appeared as a large conductivity increase with increasing thickness from 1 to 2 QL. Angle-resolved photoelectron spectroscopy and first-principles calculations reveal the confinement of bulk-like conduction band (CB) state into the vdW interface. Our analysis based on the Boltzmann equation showed that the conduction of the CB has a long mean free path compared to the surface-state conduction. This is mainly attributed to the spatial separation of the CB electrons and the donor defects located at the Bi sites.

Layered materials consisting of two-dimensional (2D) atomic frameworks have attracted much attention for their potential applications in future devices based on hetero- and nano-structures^{1–3}. Because each layer has no dangling bonds, interlayer attractive force is attributed to the van der Waals (vdW) interaction. Although electronic coupling at the vdW interface is weak, it can play a subtle but significant role in the band formation and physical properties of few-layer films. A well-known example is the direct–indirect gap transition between monolayer and multilayer MoS_2 films^{4,5}.

Bi_2Te_3 is a member of V–VI layered compounds (Bi_2Se_3 , Sb_2Te_3 , etc). The bulk crystal structure is composed of triangular-lattice Bi and Te layers stacked along [111] of the rhombohedral lattice (Fig. 1a). A set of two Bi and three Te layers, a quintuple layer (QL), is a building block of the layered structure. The stacking of the atomic layers is an ABC type (see also Fig. 5b), and thus, a rhombohedral unit cell contains three QLs. The outer Te layer (Te(1) in Fig. 1a) of a QL is adjacent to the equivalent one of the neighboring QL. The Te–Te interatomic distance⁶ between the adjacent layers (3.65 Å) is much longer than the Te–Te covalent bond length⁷ of 2.7 Å, which indicates vdW-type interaction at a QL–QL interface.

Electronic properties of Bi_2Te_3 have been extensively studied since it is an important material exhibiting a high thermoelectric power factor around room temperature⁸, and, recently, it was found that the (111) surface possesses topological surface states (TSS) characterized by novel spin texture and Dirac-cone-like dispersion^{9–11}. Although Bi_2Te_3 is a narrow-gap semiconductor, metallic conduction is often observed for melt-grown crystals and deposited thin films, which is often ascribed to native antisite defects^{12–17}. Synthesis of ultrathin films of Bi_2Te_3 is an effective way to reduce the bulk conduction and hence to extract the contribution of TSS^{18–21}. On the other hand, with decreasing thickness, the decoupling of TSS localized on opposite surfaces is altered below a critical thickness, resulting in band gap opening^{18,20}. Previous studies showed that the 4-QL film was found to be thick enough to host bulk-like gapless TSS. Below this thickness, critical difference in band structure near the band gap was indicated between 1- and 2-QL films. On the other hand, the film thinning of Bi_2Te_3 was reported to enhance thermoelectric power^{22,23}. However there is little experimental evidence about transport properties in films with thickness below 5 QL.

In this study, we investigated electronic and transport properties of a few-QL Bi_2Te_3 films by combining angle-resolved photoelectron spectroscopy (ARPES), four-point-probe (4PP) conductivity measurement and first-principles band calculation. The ultrathin films with thickness of 1–5 QL exhibited metallic electrical conduction. A large increase in sheet conductivity was observed from 1 to 2 QL due to the formation of a bulk-like conduction band (CB), whose electron density is highly concentrated at the vdW interface. The localization of the CB state prevents conducting electrons from being scattered by the Bi antisite defect.

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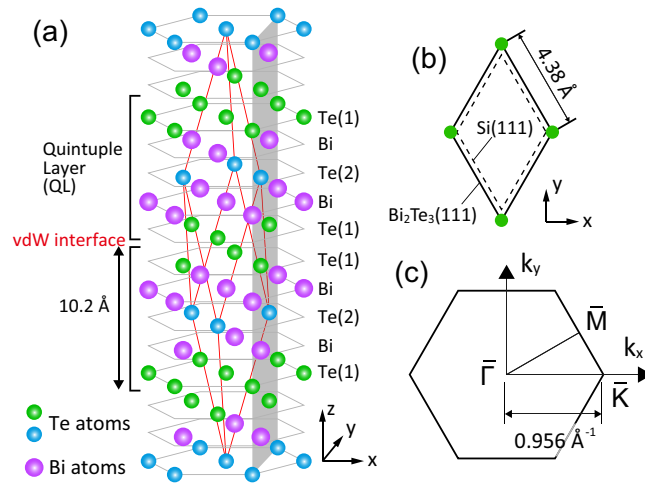


Figure 1. (a) Bulk crystal structure of Bi_2Te_3 . The (red) parallelepiped represents a rhombohedral unit cell. (b) Bi_2Te_3 and Si (111) unit cells. (c) A 2D Brillouin zone of $\text{Bi}_2\text{Te}_3(111)$.

Results and discussion

The top panels of Fig. 2 show low-energy electron diffraction (LEED) patterns observed for the Bi_2Te_3 films of 1, 1.3, 2 and 5 QL. The in-plane lattice constant is evaluated to be $4.34 \pm 0.04 \text{ \AA}$, which agrees well with that of the bulk $\text{Bi}_2\text{Te}_3(111)$ plane (4.38 \AA , Fig. 1b). The six-fold LEED pattern indicates double-domain Bi_2Te_3 films with opposite stacking sequence. Each Bi_2Te_3 spot has an arc shape, but is sharp along the radial direction, which shows that large domains of the ultrathin films are epitaxially grown on Si(111) with distribution of domains rotated by $\leq 4.9^\circ$ about the [111] axis.

The middle and lower panels of Fig. 2 show ARPES band and Fermi-surface maps around $\bar{\Gamma}$. The k_x axis is along $\bar{\Gamma}-\bar{K}$ (Fig. 1c). The 1-QL film has a metallic band with V-shaped dispersion. The band labeled SS has a hexagonal Fermi surface and the minimum energy of 0.34 eV at $\bar{\Gamma}$. The SS band energy was found to be the same between the films on n-type Si(111) (Fig. 2) and on p-type Si(111) (Fig. 4), and thus, it is independent of the substrate Fermi level (E_F) position. With increasing thickness, two additional features grow at E_F and 0.3–0.5 eV. The upper and lower bands are attributed to bulk-like CB and valence band (VB), respectively. The CB yields a small Fermi circle whose radius is evaluated to be 0.034 \AA^{-1} . Although the evolution of the SS band dispersion is not clear in the band maps, the Fermi surface changes into a warped hexagon at 1–2 QL. The Fermi surface at 2 QL is already very similar to that of TSS on the bulk surface. The clear difference in Fermi-surface shape between 1 and 2 QL indicates that the Bi_2Te_3 film grows QL by QL. For further deposition up to 5 QL, no additional band feature is seen, but the position of E_F is slightly shifted downward toward the band gap between VB and CB. The shift induces the contraction of the Fermi surfaces of SS and CB by about 20%. Since the VB maximum is located at $0.27 \pm 0.02 \text{ eV}$ for the 5-QL film, the Dirac point of TSS is estimated to be at 0.3 eV. The behavior observed at 1–5 QL is consistent with previous reports^{18,20}, and demonstrates that the few-QL films have one or more metallic states.

Figure 3a shows the temperature dependence of sheet resistivity of the Bi_2Te_3 films of thicknesses of 1, 2, 3 and 5 QL. We used low-doped Si(111) substrates ($\rho_{3D} > 1000 \text{ \Omega cm}$, n-type) in the conductivity measurements. While the conductivity in the Si bulk and surface space-charge layer rapidly drops in the low temperature (freeze-out) range^{24,25}, no sign of it is seen in all the $\rho-T$ curves, which indicates the contribution of electron conduction in the substrate is negligible. Hence, the $\rho-T$ curves evidence the metallic nature of the few-QL films. On the other hand, electron transport in ultrathin films is affected by substrate atomic steps and surface contaminations. In our study the 1-QL film must be most sensitive to scattering by such extrinsic factors. However the variation in resistivity of 1-QL films was within $\sim 10\%$, which is sufficiently small compared to the thickness-dependent decrease in resistivity. Linear functions fitted to the data at $T \geq 50 \text{ K}$ are displayed by the thin lines. The linearity represents the dominant role of electron-phonon (e -ph) scattering in the high temperature regime. With decreasing temperature below 50 K, the $\rho-T$ curves begin to deviate from the linear lines, and become nearly flat below $\sim 20 \text{ K}$. From the $\rho-T$ curves, we evaluated residual sheet conductivity σ_0 , the inverse of ρ measured at 9 K, and temperature coefficient $d\rho/dT$ in the high temperature regime. They are displayed as a function of film thickness in Figs. 3b and 3c. According to the ARPES result, the σ_0 value of the 1-QL film is directly attributed to the SS band; $\sigma_0^{\text{SS}} = 0.43 \text{ mS}$. The conductivity increase at 2 QL can be related to the formation of CB or the change of the SS band. Actually, the hexagonal Fermi surface at 1 QL and the warped one at 2 QL have a tiny difference of at most 3% in length of Fermi contours, to which carrier density in 2D is proportional. We therefore attribute the increase in σ_0 between 1 and 2 QL to the CB Fermi surface; $\sigma_0^{\text{CB}} = 0.67 \text{ mS}$.

We analyze the transport properties of the SS and CB bands by using the Boltzmann equation of 2D electrical conductivity:

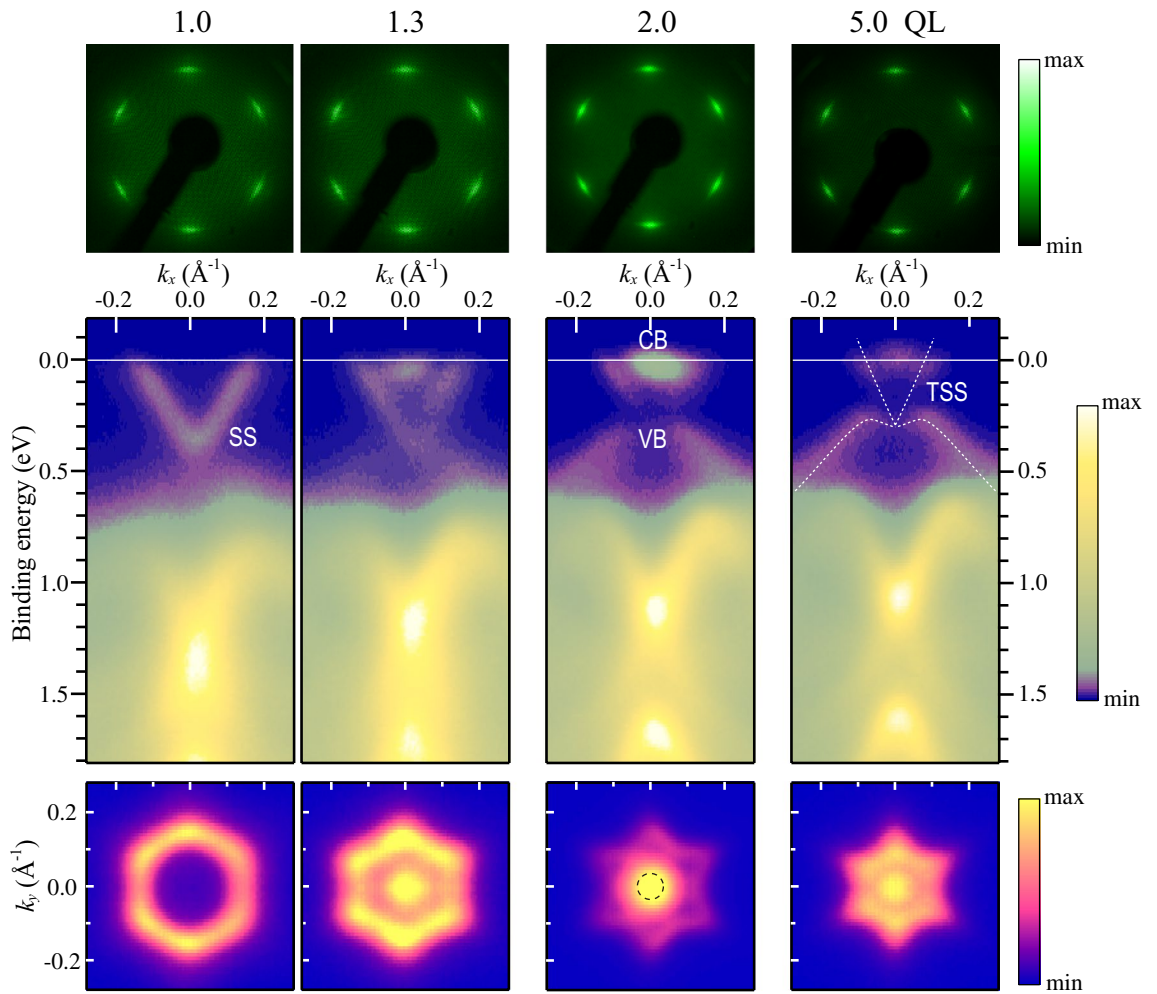


Figure 2. (Top panels) LEED patterns at 70 eV, (middle) ARPES band maps and (bottom) Fermi surface maps of the Bi_2Te_3 films at 1.0, 1.3, 2.0 and 5.0 QL. The Fermi surface maps were obtained by mirroring the data at $k_y = 0$. The dashed circle on the bottom panel at 2 QL represents the Fermi surface of the bulk-like CB. The dotted curves on the middle panel at 5 QL represent the dispersions of the TSS and VB bands.

$$\sigma = \frac{e^2 \tau}{2\pi^2 \hbar} \int \frac{v_{kx}^2}{|v_k|} dk, \tag{1}$$

where v_k is a group velocity, the integral is done on Fermi contours, and τ is a carrier relaxation time. The k_x direction here is defined along $\Gamma\bar{M}$, parallel to the array of 4PP. The scattering rate is the sum of the rates of defect scattering and phonon scattering: $\tau^{-1} = \tau_0^{-1} + \tau_{ph}^{-1}$. The first term determines σ_0 , and the second term describes the constant $d\rho/dT$ slope as $\tau_{ph}^{-1} = 2\pi \lambda_{tr} k_B T / \hbar$, where k_B is the Boltzmann constant and λ_{tr} a transport e -ph coupling constant. The group velocity was deduced from the band dispersions at E_F . For the SS band, we obtained $v_k = 0.39 \times 10^8$ cm/s along $\Gamma\bar{M}$ and 0.48×10^8 cm/s along $\Gamma\bar{K}$ from ARPES. Because the dispersion of the CB is not clear in the ARPES data, we used a theoretical value of 0.41×10^8 cm/s for the 2D free-electron like Fermi surface.

We obtained $\tau = 17$ fs from $\sigma_0^{SS} = 0.43$ mS, and $\lambda_{tr} = 0.06$ from $d\rho/dT = 2.02 \Omega/K$ at 1 QL. The magnitude of λ_{tr} is in a range of the experimental and theoretical values (0–0.1) for the surface of bulk Bi_2Te_3 ^{26–28}. A mean free path l was evaluated to be 7.4 nm by multiplying τ and averaged v_k . On the other hand, we obtained $\tau = 120$ fs and $l = 49$ nm for the CB at 2 QL, which are much longer than those for SS. The evaluation of λ_{tr} from a band-averaged τ gives $\lambda_{tr} = 0.05$, which is close to that in the 1 QL film. It is very likely that the λ_{tr} is nearly independent of thickness, and the decrease of $d\rho/dT$ with thickness is due to the increase in τ_0 and the additional contribution of the CB to the integral in eq. (1). This qualitatively explains why the curves of $d\rho/dT$ in Fig. 3c and σ_0 in 3b are similar but upside down.

In order to gain insight into the significant difference in transport property between the SS and CB bands, we explore the nature of the two states by first-principles calculations. Firstly, we compare the computed band structure of free-standing Bi_2Te_3 films with the measured one. Figures 4a and 4b show the ARPES band maps along $\Gamma\bar{K}\bar{K}\bar{M}\bar{\Gamma}$ measured on the 1-QL and the 2-QL films, respectively. The calculated electronic structure, which is expanded in energy by a factor of 1.09 to compensate an underestimate of band energies in DFT calculations, is displayed by the dashed curves. For the 1-QL film, the number of calculated valence bands is 9, which

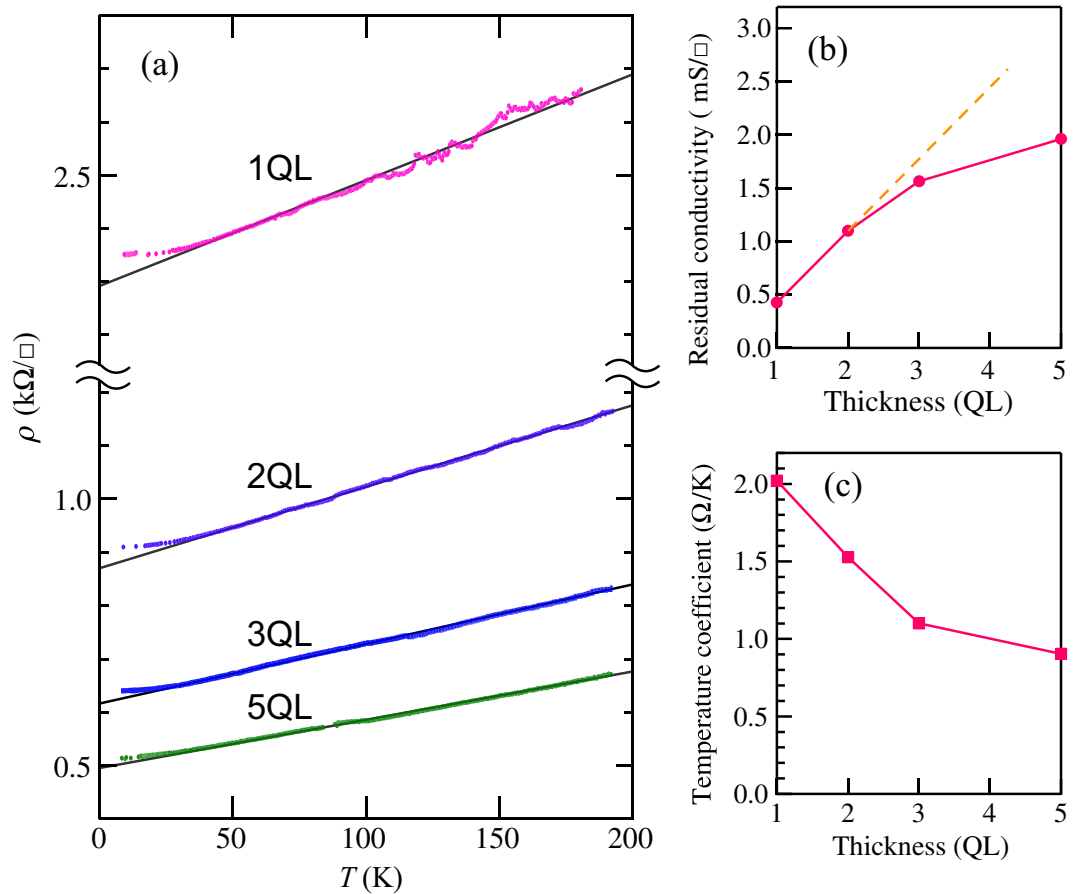


Figure 3. (a) Temperature dependence of ρ of the 1-, 2-, 3-, and 5-QL Bi_2Te_3 films measured during heating from 9 K. The fitting lines are depicted by the solid lines. The symbol \square in the vertical axis label is used to differentiate sheet resistivity ρ from resistance. Thickness dependence of (b) residual sheet conductivity and (c) linear temperature coefficients of $\rho(T)$. The dashed line in (b) represents the expectation as conductivity increases with the number of the vdW interfaces.

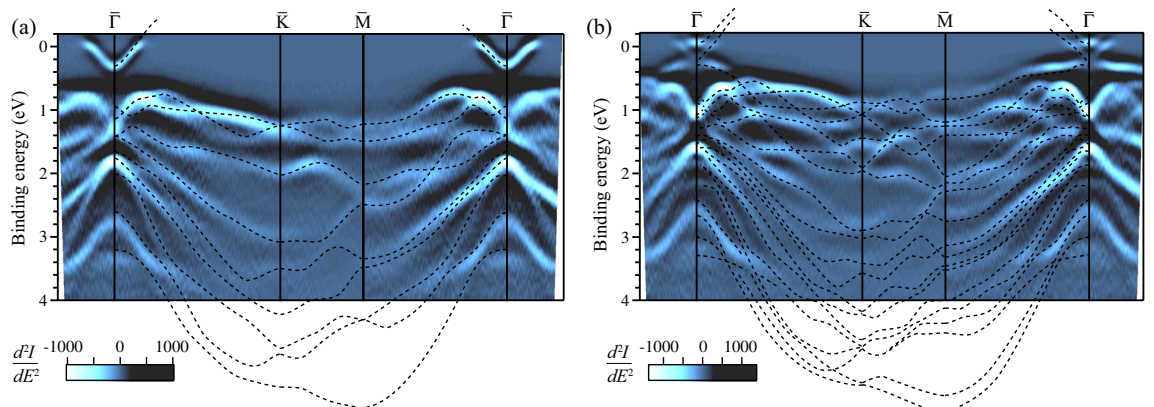


Figure 4. Measured band structure of the (a) 1-QL and (b) 2-QL Bi_2Te_3 films along $\bar{\Gamma}-\bar{K}-\bar{M}-\bar{\Gamma}$. These are second-derivative ARPES intensity maps. Lower negative second derivatives (d^2I/dE^2) are colored brighter to highlight peaks in energy distribution curves. The dashed curves are calculated band structure of the free-standing 1-QL and 2-QL Bi_2Te_3 films.

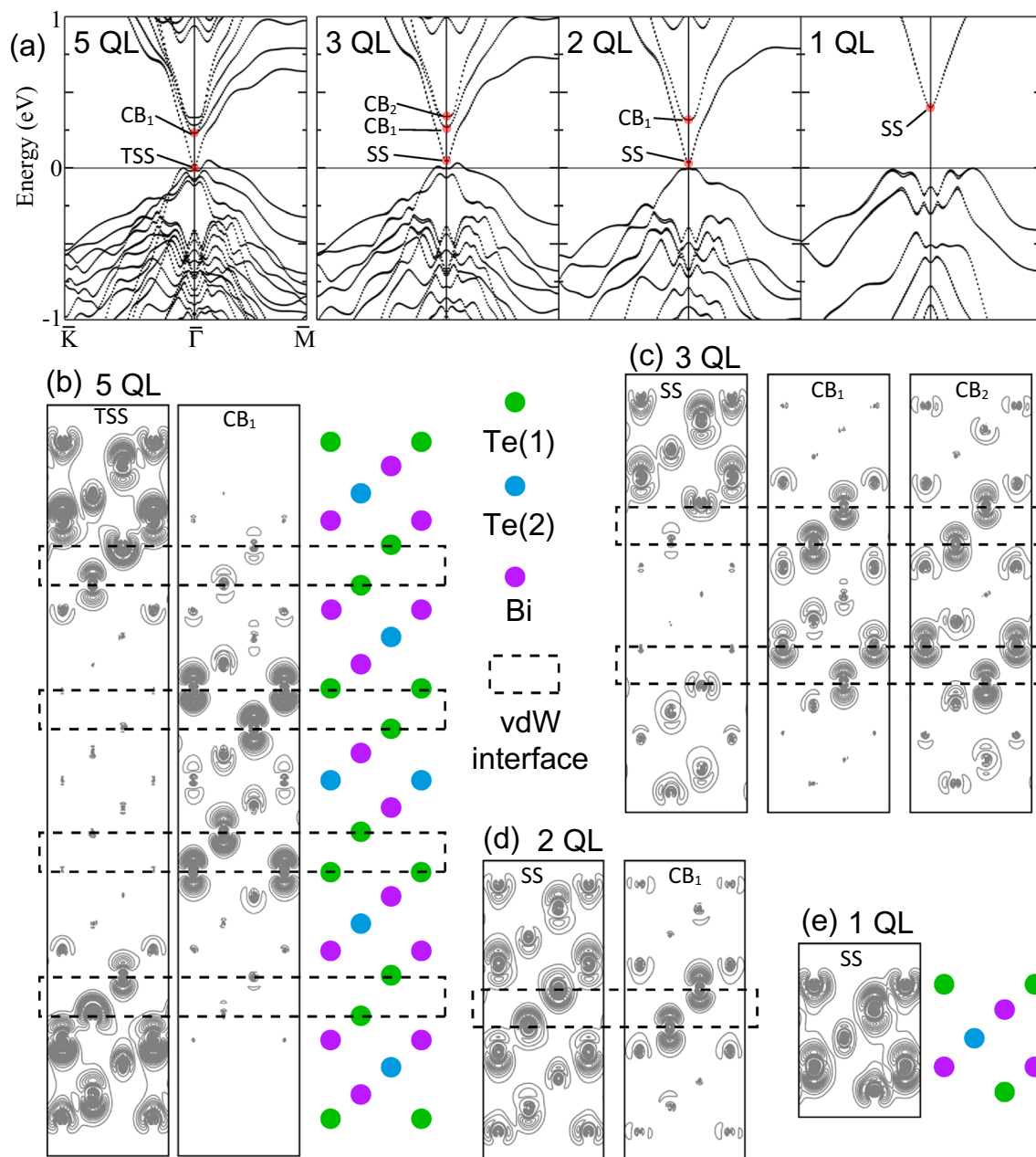


Figure 5. (a) Calculated band structure of the 5-, 3-, 2- and 1-QL films. For the states (TSS (SS) and CB states) marked in (a), electron density contour maps are drawn in (b–e) on the y - z plane (the gray parallelogram in Fig. 1a). The dotted rectangles indicate the vdW interfaces.

corresponds to the sum of six 6p electrons from Bi atoms and twelve 5p electrons from Te atoms. The details of theoretical band dispersions show an excellent agreement with the experimental ones for both films over the whole 2D Brillouin zone.

Figure 5a shows the calculated band structure in the vicinity of E_F for the bulk-like 5-QL and thinner 3-, 2- and 1-QL films. On the 5-QL film, the TSS band contacts with the VB at Γ and $E = 0$ eV. At higher energies, there are four CBs. While the TSS band and the CB have similar dispersion relations, their electron density distribution is different as shown in Fig. 5b. The TSS is confined in the outmost QLs and has considerably small electron density in the inner three QLs, which is the evidence of the decoupling of TSS on the both outmost QLs. On the other hand, a CB state (CB_1) exhibits a high concentration of electron density on the Te(1) atoms faced with two middle vdW interfaces. The other CB states also show electron density peaks at vdW interfaces with different distributions. Moreover, it should be noted that the CB states is mainly derived from the Te(1) orbitals in contrast to the SS with comparable contributions from Te and Bi orbitals. For the thinner films, a band gap is seen at $E = 0$ eV, indicating a transition from nontrivial TSS to SS. As to CBs and VBs, their numbers are decreased as $n - 1$, where n is the number of QL. The localization of the CB states into vdW interfaces is preserved as shown

in Fig. 5c, d. For the 1-QL film, only an unoccupied band is seen. Its electron density distribution (Fig. 5e) has the common nature with the SS (TSS) rather than the CB state.

We now turn back to the transport properties of the SS band and the CB. Relaxation time was evaluated from the conductivity measured at 9 K. In the low-temperature regime, phonons freeze out. On the other hand, donor sites are still ionized, which is confirmed by the metallic behavior of ρ in Fig. 3a. Metallic conduction with n-type carriers was observed for Te-rich Bi_2Te_3 samples^{12,14}. DFT calculations showed the lowest formation energy of the Bi antisite defect^{15,16}, at which a Bi atom is substituted by Te. The calculation showed a defect-induced resonance lying just above the CB minimum¹⁵. This is consistent with the fact that metallic conduction was observed at low temperatures. The comparison of the electron density maps of the SS and CB states reveals that the conduction through the SS band is affected more strongly by the Bi antisite defects than that through the CB. We therefore attribute the shorter relaxation time for the SS to the scattering by the Bi antisite defects. Because the Bi antisite defect is a single electron donor, we obtained for the 2-QL film a defect density, $n_d = 1.83 \times 10^{12}/\text{cm}^2$ from the area of the observed CB Fermi surface. The average distance of the antisite defects is estimated to be $\sqrt{1/n_d} \sim 7$ nm, which is comparable with the mean free path for the SS conduction (7.4 nm).

The band calculations of the few-QL films also provide a simple description of the conductivity above 2 QL. The increase in number of the CB with thickness causes the increase in carrier density. Assuming the common dispersion of the CB states, the conductivity of the n -QL film is expressed as $\sigma(n) = \sigma_{\text{SS}} + (n - 1)\sigma_{\text{CB}}$, which is shown by the dashed line in Fig. 3b. This expression is qualitatively consistent with the total conductance in a parallel circuit consisting of the vdW interface and the surface. The estimated $\sigma(3)$ (1.8 mS) roughly agrees with the measured $\sigma_0 = 1.56$ mS. Actually, ARPES showed that the CB minimum is shifted upward from 0.1 eV below E_F with increasing thickness. In addition, the calculated CB states for $\gtrsim 3$ QL have energy spread of 0.05–0.1 eV at $\bar{\Gamma}$. Therefore the conductivity increase due to the CB must be limited above 3 QL. On the other hand, the transition from SS to TSS at 5 QL is expected to induce a large increase in conductivity because carrier back-scattering for the TSS is suppressed by spin-momentum locking. In the previous study, a very high mobility for TSS ($4600 \text{ cm}^2/\text{Vs}$ at 14 K) was shown for Bi_2Te_3 single-crystalline ultrathin films²¹. However the conductivity increase observed from 3-QL to 5-QL films is only 0.5 mS, which is smaller than those by the CB at 1–2 QL and 2–3 QL. This result is attributed to the coexistence of inversely-stacked domains in our Bi_2Te_3 films. The spin polarization of TSS is reversed between surfaces of inversely-stacked domains, and thus, the domain boundary strongly hinders the transport of the TSS carriers.

Finally we describe the anisotropy of the carrier transport of Bi_2Te_3 ^{29,30}. For the 2-QL film, a mobility of $2300 \text{ cm}^2/\text{Vs}$ was obtained from a CB carrier density n_d and σ_0^{CB} . This value is considerably high compared with $300 \text{ cm}^2/\text{Vs}$ reported for 500-nm-thick films with a similar n-type carrier concentration¹⁴. While the mobility measured for the thicker films contains both in-plane and out-of-plane conduction, our measurement of the 2-QL film evaluates only the in-plane conduction. Therefore the high mobility for the 2-QL film is related to the strong anisotropy of the CB carrier transport as reported for bulk single crystals²⁹. Nevertheless, taking into consideration the critical role of domain boundary scattering in electrical conduction in ultrathin films, the high mobility is surprising. We note that the mean free path (49 nm) for the CB is longer than the mean domain size (6–8 nm) evaluated from the LEED spot width in the radial direction (Fig. 2). This suggests a low barrier for CB carrier transport across the domain boundaries.

Conclusions

In summary, we have shown the critical role of the vdW interface in electronic structure and electrical conduction in the few-QL Bi_2Te_3 films grown by MBE. We observed the large increase in electrical conductivity with the formation of the bulk-like CB associated with the vdW interface. Although TSS is not preserved in the Bi_2Te_3 films with thickness below 4 QL, the CB state exhibits high sheet conductivity and mobility due to the separation of conducting electrons from the donor defect site. The localized nature of the CB state is expected to be effective for reducing the influence of surface contamination by adsorbates or a capping layer. This property is useful for fabricating robust atomically-thin metallic films or wires. Finally, it should be noted that the vdW interface state for the 2-QL film is confined within only two-atomic-layer thickness as shown in Fig. 5d. The interface electrons will provide a new platform for studying quantum properties of 2D electrons. For example, the evolution of 2D magnetic order mediated by the 2D metallic state can be addressed by the intercalation of magnetic atoms, such as Cr³¹, into the vdW interface.

Methods

Few-QL Bi_2Te_3 films were grown by molecular-beam epitaxy (MBE) with a polycrystalline Bi_2Te_3 source in an alumina crucible heated at 700 K. As a substrate, we used the Bi/Si(111) $\beta\text{-}\sqrt{3} \times \sqrt{3}$ surface where the dangling bonds on Si(111) are fully terminated by Bi adatoms³². A typical growth rate of 0.2 QL/min was obtained on the substrates at room temperature while keeping back-ground pressure below 5×10^{-8} Pa. Deposited films were annealed at 370 K for 1 min. The moderate postannealing reduced the background intensity of LEED, which is due to the ordering of the films as well as the desorption of excess Bi_2Te_3 fragments from the film surface.

We performed ARPES and conductivity experiments in different ultrahigh vacuum (UHV) chambers with base pressure less than 1×10^{-8} Pa. All ARPES measurements were performed at room temperature by a R3000 electron energy analyzer (VG Scienta) and monochromatized He I α radiation ($h\nu = 21.2$ eV). In situ electrical conductivity measurements were carried out by using a home-built 4PP with a probe spacing of 0.8 mm. The 4PP was put almost in the center of a sample with the size of $10 \times 4 \text{ mm}^2$. A Si(111) substrate was replaced by a new one after each 4PP measurement because the contact marks of the 4PP affected the uniformity of the film formed subsequently. Resistance was obtained from the slope of I - V curves measured in $|I| < 1 \mu\text{A}$, and converted into sheet resistivity ρ by multiplying by a geometrical correction factor³³. All-electron band calculation was done

for free-standing Bi₂Te₃ films by the WIEN2k code³⁴ implemented with the full-potential linearized augmented plane wave plus local orbitals (APW+lo) method and the PBE96 generalized gradient approximation (GGA)³⁵.

Data availability

The authors declare that the data supporting the findings of this study are available within the paper.

Received: 13 August 2020; Accepted: 24 February 2021

Published online: 11 March 2021

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Acknowledgements

The present work was financially supported by JSPS KAKENHI (Grants No. 15H03675, No. 15K21112, No. 18K03491, and No.19H01825).

Author contributions

S.H. designed and planned the experiments. S.H. and K.O. conducted the experiments. T.A. performed the band calculations. T.A. and H.O. supervised the project. S.H. and T.A. wrote the manuscript. All the authors discussed the results.

Competing interests

The authors declare no competing interests.

Additional information

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